

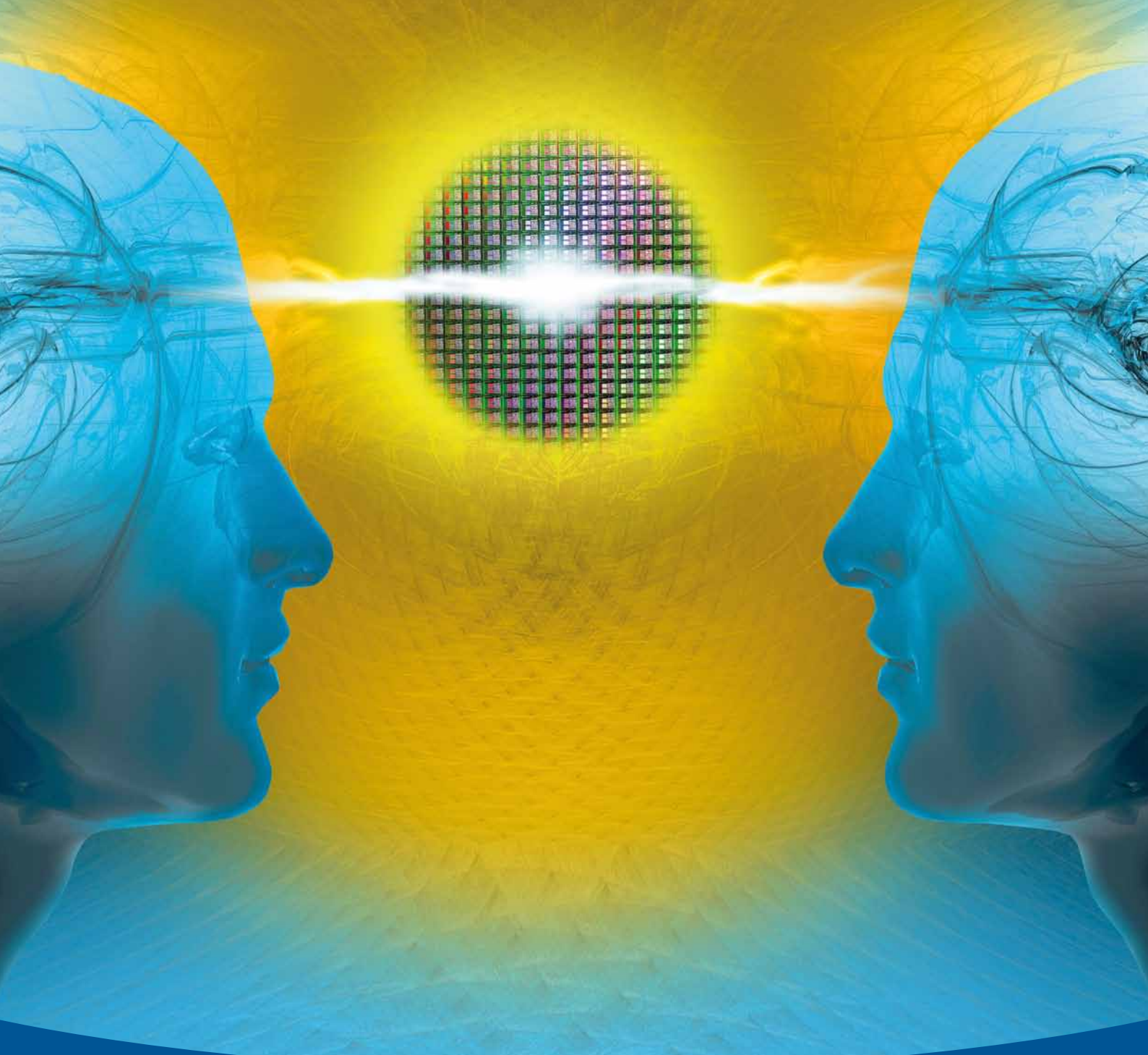
DATASHEET

GENESIS

IGBT Module with SiC diodes for residential photovoltaic inverters

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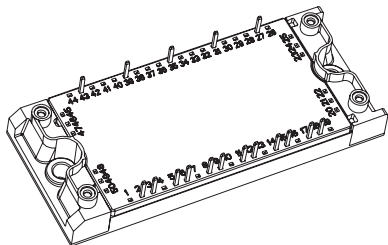
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BOOST SINGLE PHASE INVERTER, 50 A



ECONO2

PRODUCT SUMMARY

| | |
|-----------------------------------|-----------|
| V_{CES} | 600 V |
| $V_{CE(on)}$ (typical) at 50 A | 1.65 V |
| t_{sc} at $T_J = 150\text{ °C}$ | 5 μ s |
| I_C at $T_C = 95\text{ °C}$ | 50 A |

FEATURES

- Low $V_{CE(on)}$ Trench IGBT technology
- Silicon carbide diode technology
- FRED Pt® 1.0 diode
- 5 μ s short circuit capability
- Square RBSOA
- Positive $V_{CE(on)}$ temperature coefficient
- Low stray inductance design
- Speed 4 kHz to 30 kHz
- Compliant to RoHS Directive 2002/95/EC
- Designed and qualified for industrial market



BENEFITS

- Benchmark efficiency for power converter
- Rugged transient performance
- Low EMI, requires less snubbing
- Direct mounting to heatsink
- PCB solderable terminals
- Low junction to case thermal resistance

ABSOLUTE MAXIMUM RATINGS

| | PARAMETER | SYMBOL | TEST CONDITIONS | MAX. | UNITS |
|--|--|----------------------|----------------------|---------------|--------------------|
| | Maximum operating junction temperature | T_J | | 175 | $^{\circ}\text{C}$ |
| | Storage temperature range | T_{Stg} | | - 40 to + 175 | |
| | Isolation voltage | V_{ISOL} | AC (1 min) | 2500 | V |
| Single Phase Inverter Q1 to Q4, D1 to D4 | Collector to emitter voltage | V_{CES} | | 600 | V |
| | Gate to emitter voltage | V_{GES} | | ± 20 | |
| | Continuous collector current | I_C | $T_C = 25\text{ °C}$ | 75 | A |
| | | | $T_C = 80\text{ °C}$ | 56 | |
| | Pulsed collector current | I_{CM} | | 192 | A |
| | Clamped inductive load current | I_{LM} | | 192 | A |
| | Power dissipation (IGBT) | P_D | $T_C = 25\text{ °C}$ | 200 | W |
| | | | $T_C = 80\text{ °C}$ | 127 | |
| AP diode continuous forward current | I_F | $T_C = 25\text{ °C}$ | 27 | A | |
| | | $T_C = 80\text{ °C}$ | 19 | | |
| Boost QB, DB, D1b | Collector to emitter voltage | V_{CES} | | 600 | V |
| | Gate to emitter voltage | V_{GES} | | ± 20 | |
| | Continuous collector current | I_C | $T_C = 25\text{ °C}$ | 75 | A |
| | | | $T_C = 80\text{ °C}$ | 56 | |
| | Pulsed collector current | I_{CM} | | 192 | A |
| | Clamped inductive load current | I_{LM} | | 192 | A |
| | Power dissipation (IGBT) | P_D | $T_C = 25\text{ °C}$ | 200 | W |
| | | | $T_C = 80\text{ °C}$ | 127 | |
| | Repetitive peak reverse voltage boost diode DB | V_{RRM} | | 600 | V |
| | Continuous forward current boost diode DB | I_F | $T_C = 25\text{ °C}$ | 40 | A |
| $T_C = 80\text{ °C}$ | | | 29 | | |
| Continuous forward current anti parallel diode D1b | I_F | $T_C = 25\text{ °C}$ | 76 | A | |
| | | $T_C = 80\text{ °C}$ | 50 | | |
| Capacitor | Maximum DC voltage | $V_{max.}$ | | 500 | V |
| | Repetitive peak reverse voltage | V_{RRM} | | 600 | V |
| By Pass Diode | Continuous forward current | I_F | $T_C = 25\text{ °C}$ | 65 | A |
| | | | $T_C = 80\text{ °C}$ | 40 | |

| ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise noted) | | | | | | | |
|---|--|---|---|------|------|-------|-------|
| | PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS |
| Single Phase Inverter IGBT | Collector to emitter breakdown voltage | BV _(CES) | V _{GE} = 0 V, I _C = 500 μA | 600 | - | - | V |
| | Temperature coefficient of breakdown voltage | ΔV _{(BR)CES} /ΔT _J | V _{GE} = 0 V, I _C = 1 mA (25 °C to 175 °C) | - | 0.3 | - | V/°C |
| | Collector to emitter voltage | V _{CE(on)} | I _C = 25 A, V _{GE} = 15 V | - | 1.35 | - | V |
| | | | I _C = 50 A, V _{GE} = 15 V | - | 1.65 | - | |
| | | | I _C = 25 A, V _{GE} = 15 V, T _J = 125 °C | - | 1.50 | - | |
| | | | I _C = 50 A, V _{GE} = 15 V, T _J = 125 °C | - | 2.05 | - | |
| | Gate threshold voltage | V _{GE(th)} | V _{CE} = V _{GE} , I _C = 250 μA | 4.0 | - | 6.5 | |
| | Threshold voltage temperature coefficient | ΔV _{GE(th)} /ΔT _J | V _{CE} = V _{GE} , I _C = 1 mA (25 °C to 175 °C) | - | 6.0 | - | mV/°C |
| | Zero gate voltage collector current | I _{CES} | V _{GE} = 0 V, V _{CE} = 600 V | - | 1.0 | 150 | μA |
| | | | V _{GE} = 0 V, V _{CE} = 600 V, T _J = 125 °C | - | 450 | - | |
| | Gate to emitter leakage current | I _{GES} | V _{GE} = ± 20 V | - | - | ± 200 | nA |
| | Total gate charge (turn-on) | Q _G | I _C = 50 A V _{CC} = 400 V V _{GE} = 15 V | - | 95 | - | nC |
| | Gate to emitter charge (turn-on) | Q _{GE} | | - | 28 | - | |
| | Gate to collector charge (turn-on) | Q _{GC} | | - | 35 | - | |
| | Turn-on switching loss | E _{on} | I _C = 50 A, V _{CC} = 400 V V _{GE} = 15 V, R _g = 10 Ω L = 200 μH, T _J = 25 °C ⁽¹⁾ | - | 0.3 | - | mJ |
| | Turn-off switching loss | E _{off} | | - | 1.3 | - | |
| | Total switching loss | E _{tot} | | - | 1.6 | - | |
| | Turn-on switching loss | E _{on} | I _C = 50 A, V _{CC} = 400 V V _{GE} = 15 V, R _g = 10 Ω L = 200 μH, T _J = 125 °C ⁽¹⁾ | - | 0.8 | - | mJ |
| | Turn-off switching loss | E _{off} | | - | 1.65 | - | |
| | Total switching loss | E _{tot} | | - | 2.45 | - | |
| | Turn-on delay time | t _{d(on)} | I _C = 50 A, V _{CC} = 400 V V _{GE} = 15 V, R _g = 10 Ω L = 200 μH, T _J = 125 °C | - | 55 | - | ns |
| | Rise time | t _r | | - | 45 | - | |
| | Turn-off delay time | t _{d(off)} | | - | 165 | - | |
| | Fall time | t _f | | - | 45 | - | |
| | Input capacitance | C _{ies} | V _{GE} = 0 V V _{CC} = 30 V f = 1 MHz | - | 3025 | - | pF |
| | Output capacitance | C _{oes} | | - | 245 | - | |
| | Reverse transfer capacitance | C _{res} | | - | 90 | - | |
| Reverse bias safe operating area | RBSOA | T _J = 175 °C, I _C = 192 A R _g = 27 Ω, V _{GE} = 15 V to 0 V | Fullsquare | | | | |
| Short circuit safe operating area | SCSOA | V _{CC} = 400 V to V _P = 600 V R _g = 10 Ω, V _{GE} = 15 V to 0 V | 5 | - | - | μs | |
| Single Phase Inverter Diode | Reverse recovery parameters | I _{rr} | T _J = 125 °C | - | 2.1 | - | A |
| | | t _{rr} | V _{CC} = 200 V, I _F = 20 A | - | 43 | - | ns |
| | | Q _{rr} | dI/dt = 200 A/μs | - | 46 | - | nC |
| Diode forward voltage drop | V _{FM} | I _F = 20 A | - | 1.4 | - | V | |
| | | I _F = 20 A, T _J = 125 °C | - | 1.67 | - | | |
| Capacitor | C value | C | T _J = 25 °C | 59.4 | 66 | 72.6 | nF |
| By Pass Diode | Diode forward voltage drop | V _{FM} | I _F = 30 A | - | 1.1 | - | V |
| | | | I _F = 30 A, T _J = 125 °C | - | 1.0 | - | |
| | Breakdown voltage | V _{BR} | I _{rr} = 100 μA | 600 | - | - | |
| | Leakage current | I _{RM} | V _{RR} = 600 V | - | - | 0.05 | mA |
| V _{RR} = 600 V, T _J = 125 °C | | | - | - | 1.0 | | |

| ELECTRICAL SPECIFICATIONS ($T_J = 25\text{ }^\circ\text{C}$ unless otherwise noted) | | | | | | | | |
|--|--|---|--|---|-------|---------------|----------------------------|---|
| | PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNITS | |
| Boost IGBT | Collector to emitter breakdown voltage | $BV_{(CES)}$ | $V_{GE} = 0\text{ V}, I_C = 500\text{ }\mu\text{A}$ | 600 | - | - | | |
| | Temperature coefficient of breakdown voltage | $\Delta V_{(BR)CES}/\Delta T_J$ | $V_{GE} = 0\text{ V}, I_C = 1\text{ mA}$ ($25\text{ }^\circ\text{C}$ to $175\text{ }^\circ\text{C}$) | - | 0.3 | - | $\text{V}/^\circ\text{C}$ | |
| | Collector to emitter voltage | $V_{CE(on)}$ | $I_C = 25\text{ A}, V_{GE} = 15\text{ V}$ | - | 1.35 | - | V | |
| | | | $I_C = 50\text{ A}, V_{GE} = 15\text{ V}$ | - | 1.65 | - | | |
| | | | $I_C = 25\text{ A}, V_{GE} = 15\text{ V}, T_J = 125\text{ }^\circ\text{C}$ | - | 1.50 | - | | |
| | | | $I_C = 50\text{ A}, V_{GE} = 15\text{ V}, T_J = 125\text{ }^\circ\text{C}$ | - | 2.05 | - | | |
| | Gate threshold voltage | $V_{GE(th)}$ | $V_{CE} = V_{GE}, I_C = 250\text{ }\mu\text{A}$ | 4.0 | - | 6.5 | | |
| | Threshold voltage temperature coefficient | $\Delta V_{GE(th)}/\Delta T_J$ | $V_{CE} = V_{GE}, I_C = 1\text{ mA}$ ($25\text{ }^\circ\text{C}$ to $175\text{ }^\circ\text{C}$) | - | - 6.0 | - | $\text{mV}/^\circ\text{C}$ | |
| | Zero gate voltage collector current | I_{CES} | $V_{GE} = 0\text{ V}, V_{CE} = 600\text{ V}$ | - | 1.0 | 150 | μA | |
| | | | $V_{GE} = 0\text{ V}, V_{CE} = 600\text{ V}, T_J = 125\text{ }^\circ\text{C}$ | - | 450 | - | | |
| | Gate to emitter leakage current | I_{GES} | $V_{GE} = \pm 20\text{ V}$ | - | - | ± 200 | nA | |
| | Total gate charge (turn-on) | Q_G | $I_C = 50\text{ A}$ $V_{CC} = 400\text{ V}$ $V_{GE} = 15\text{ V}$ | - | 95 | - | nC | |
| | Gate to emitter charge (turn-on) | Q_{GE} | | - | 28 | - | | |
| | Gate to collector charge (turn-on) | Q_{GC} | | - | 35 | - | | |
| | Turn-on switching loss | E_{on} | $I_C = 50\text{ A}, V_{CC} = 400\text{ V}$ $V_{GE} = 15\text{ V}, R_g = 10\text{ }\Omega$ $L = 200\text{ }\mu\text{H}, T_J = 25\text{ }^\circ\text{C}^{(1)}$ | - | 0.3 | - | mJ | |
| | Turn-off switching loss | E_{off} | | - | 1.3 | - | | |
| | Total switching loss | E_{tot} | | - | 1.6 | - | | |
| | Turn-on switching loss | E_{on} | | $I_C = 50\text{ A}, V_{CC} = 400\text{ V}$ $V_{GE} = 15\text{ V}, R_g = 10\text{ }\Omega$ $L = 200\text{ }\mu\text{H}, T_J = 125\text{ }^\circ\text{C}^{(1)}$ | - | 0.8 | | - |
| | Turn-off switching loss | E_{off} | | | - | 1.65 | | - |
| | Total switching loss | E_{tot} | | | - | 2.45 | | - |
| | Turn-on delay time | $t_{d(on)}$ | $I_C = 50\text{ A}, V_{CC} = 400\text{ V}$ $V_{GE} = 15\text{ V}, R_g = 10\text{ }\Omega$ $L = 200\text{ }\mu\text{H}, T_J = 125\text{ }^\circ\text{C}$ | - | 55 | - | ns | |
| | Rise time | t_r | | - | 45 | - | | |
| | Turn-off delay time | $t_{d(off)}$ | | - | 165 | - | | |
| | Fall time | t_f | | - | 45 | - | | |
| | Input capacitance | C_{ies} | $V_{GE} = 0\text{ V}$ | - | 3025 | - | pF | |
| | Output capacitance | C_{oes} | $V_{CC} = 30\text{ V}$ | - | 245 | - | | |
| | Reverse transfer capacitance | C_{res} | $f = 1\text{ MHz}$ | - | 90 | - | | |
| Reverse bias safe operating area | RBSOA | $T_J = 175\text{ }^\circ\text{C}, I_C = 192\text{ A}$ $R_g = 27\text{ }\Omega, V_{GE} = 15\text{ V to }0\text{ V}$ | Fullsquare | | | | | |
| Short circuit safe operating area | SCSOA | $V_{CC} = 400\text{ V to }V_P = 600\text{ V}$ $R_g = 10\text{ }\Omega, V_{GE} = 15\text{ V to }0\text{ V}$ | 5 | - | - | μs | | |
| AP Diode of Boost IGBT | Diode forward voltage drop | V_{FM} | $I_F = 50\text{ A}$ | - | 1.91 | - | V | |
| | | | $I_F = 50\text{ A}, T_J = 125\text{ }^\circ\text{C}$ | - | 1.49 | - | | |
| | Reverse recovery parameters | I_{rr} | $T_J = 125\text{ }^\circ\text{C}$ | - | 18 | - | A | |
| | | | $V_{CC} = 200\text{ V}, I_F = 50\text{ A}$ $di/dt = 500\text{ A}/\mu\text{s}$ | - | 115 | - | ns | |
| | | Q_{rr} | - | 1100 | - | nC | | |
| Boost Diode | Breakdown voltage | V_{BR} | $I_{rr} = 100\text{ }\mu\text{A}$ | 600 | - | - | V | |
| | Leakage current | I_{RM} | $V_{rr} = 600\text{ V}$ | - | - | 100 | μA | |
| | Diode forward voltage drop | V_{FM} | $I_F = 30\text{ A}$ | - | 1.4 | - | V | |
| | | | $I_F = 30\text{ A}, T_J = 125\text{ }^\circ\text{C}$ | - | 1.67 | - | | |
| | Reverse recovery parameters | I_{rr} | $T_J = 125\text{ }^\circ\text{C}$ | - | 3.6 | - | A | |
| | | | $V_{CC} = 200\text{ V}, I_F = 30\text{ A}$ $di/dt = 500\text{ A}/\mu\text{s}$ | - | 26 | - | ns | |
| Q_{rr} | | | - | 46 | - | nC | | |

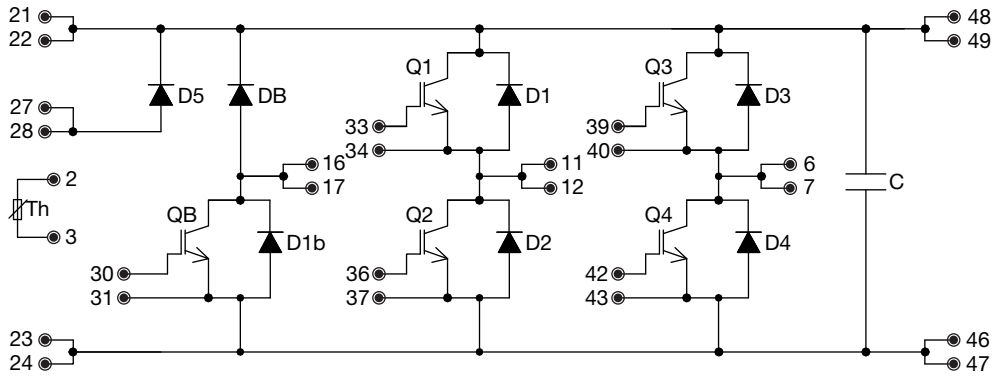
Note

(1) Energy losses include "tail" and diode reverse recovery

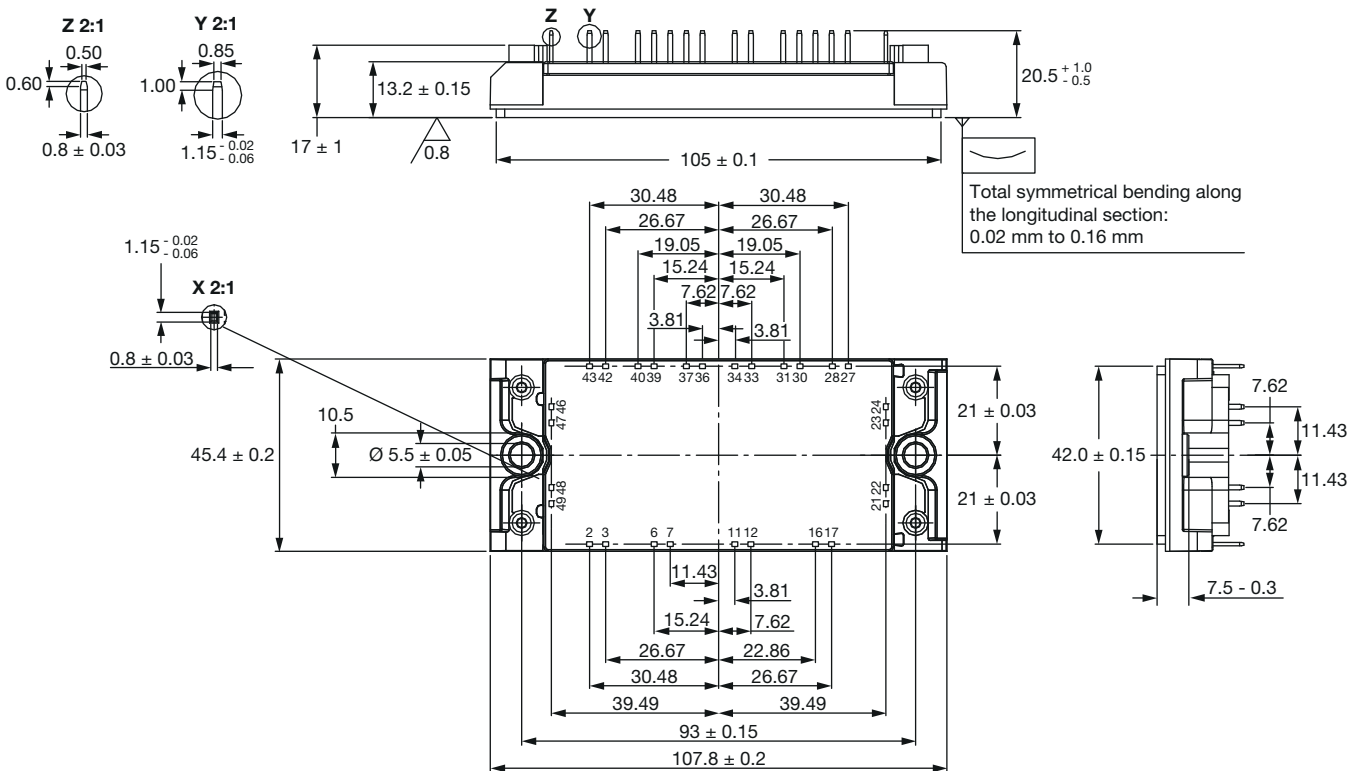
THERMAL AND MECHANICAL SPECIFICATIONS

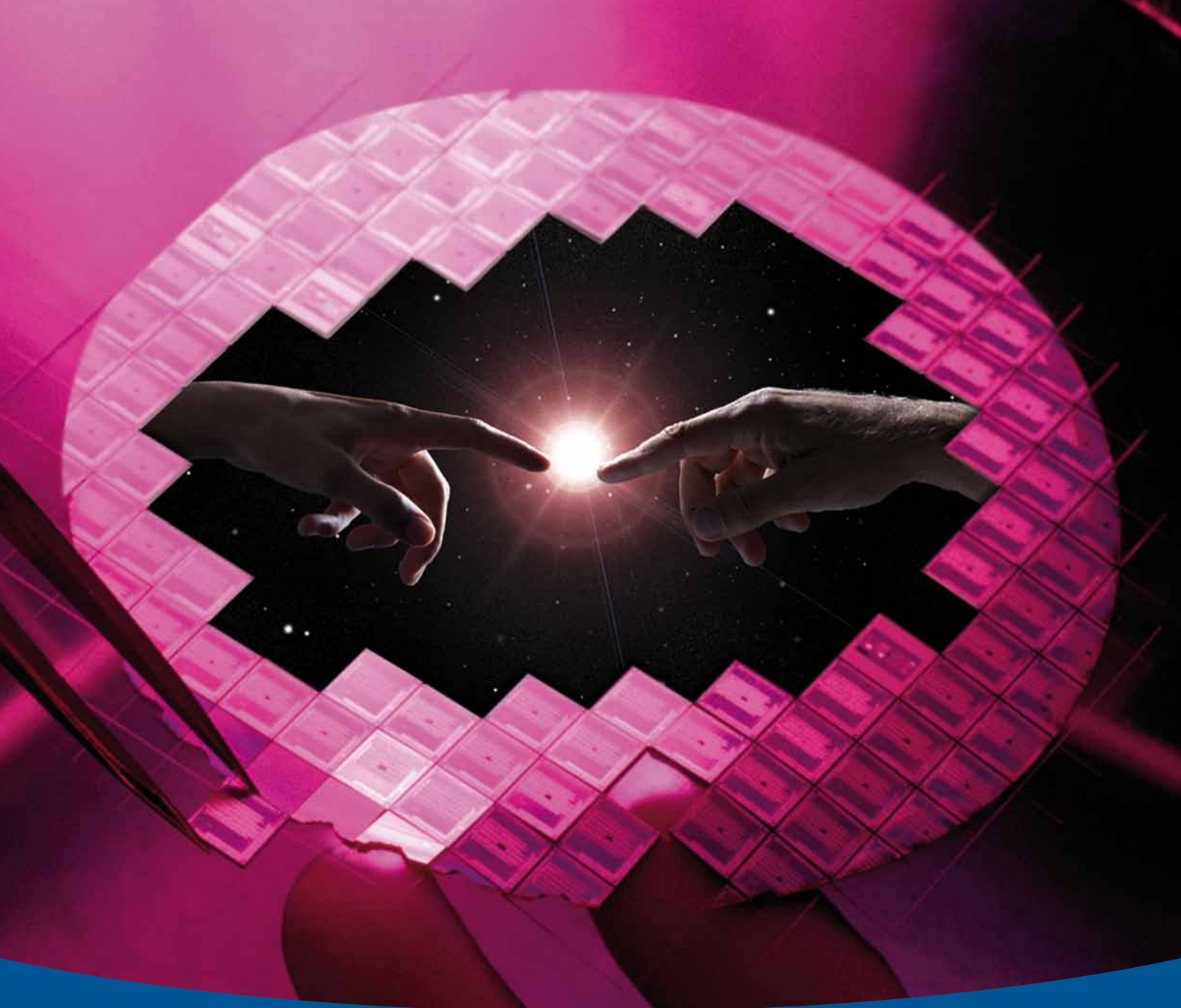
| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNITS |
|--|------------|------|------|------|----------------------|
| Junction to case single phase inverter IGBT thermal resistance | R_{thJC} | - | - | 0.75 | $^{\circ}\text{C/W}$ |
| Junction to case single phase inverter diode thermal resistance | | - | - | 2.71 | |
| Junction to case boost diode thermal resistance | | - | - | 1.8 | |
| Junction to case anti parallel diode boost IGBT thermal resistance | | - | - | 0.87 | |
| Junction to case boost IGBT thermal resistance | | - | - | 0.75 | |
| Junction to case by pass diode thermal resistance | | - | - | 1.5 | |
| Case to sink, flat, greased surface | R_{thCS} | - | 0.05 | - | |
| Mounting torque (M5) | | 2.7 | - | 3.3 | Nm |
| Weight | | - | 170 | - | g |

CIRCUIT CONFIGURATION



DIMENSIONS (mm)





GENESIS – Let there be Chips!

IGBT Module from Vishay and EBV for Use in Photovoltaic Systems in Private Homes

GENESIS, part of the EBVchips programme, is a power-stage module for residential single-phase photovoltaic inverters. It provides standard boost bridge topology with trench IGBTs and SiC diodes for higher efficiency and lower EMI.

GENESIS comes in a well-proven Econo 2 RoHS-compliant package with copper base plate and PCB solder terminals, and is a reliable solution designed and qualified for the industrial sector. Like all EBVchips, it is a standard product that is available world wide exclusively from EBV Elektronik.

For all information, design know-how and application support please contact your local partner of EBV Elektronik, the leading specialist in EMEA semiconductor distribution, or check under ebv.com/genesis.

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